

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S2	3694	451/5,41.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/08/30 13:35
S3	5325	427/127,128.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/08/30 13:33
S4	6931	360/121-126,317.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/08/30 13:33
S5	5215	29/592.1,603.12-603.16,603.18, 829,831,851,885.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:30
S6	1	(substrate or wafer) near (trench\$2 or cavit\$3) near coil	USPAT; JPO; DERWENT	OR	ON	2005/08/30 14:14
S7	802	(trench\$2 or cavit\$3) near coil	USPAT; JPO; DERWENT	OR	ON	2005/08/30 13:39
S9	894	etch\$3 near (substrate or wafer) near (trench\$2 or cavit\$3)	USPAT; JPO; DERWENT	OR	ON	2005/08/30 14:12
S10	0	S7 and S9	USPAT; JPO; DERWENT	OR	ON	2005/08/30 13:39
S11	98	(trench\$2 or cavit\$3) near (form\$3 or embedd\$3) near coil	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:28
S12	1	S5 and S11	USPAT; JPO; DERWENT	OR	ON	2005/08/30 13:40
S13	26	("4102683"   "4652954"   "4684438"   "5034089"   "5045417"   "5126220"   "5153083"   "5414580"   "5448822"   "5515221"   "5566442"   "5621592"   "5649351"   "5658470"   "5665251"   "5666249"   "5681426"   "5695656"   "5700380"   "5729887"   "5742458"   "5779923"   "5894388"   "6226149"   "6304414"   "6515826").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/30 13:40
S14	4	(trench\$2 or cavit\$3) near (embedd\$3) near coil	USPAT; JPO; DERWENT	OR	ON	2005/08/30 14:02

S15	116	HAN-CHERNG-CHYI.in. or CHEN-MAO-MIN.in. or WANG-PO-KANG.in.	USPAT; JPO; DERWENT	OR	ON	2005/08/30 14:02
S16	0	S9 and S15	USPAT; JPO; DERWENT	OR	ON	2005/08/30 14:03
S17	2	S7 and S15	USPAT; JPO; DERWENT	OR	ON	2005/08/30 14:03
S18	5	("6304414"   "6317280"   "6325947"   "6333830"   "6339523").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/30 14:06
S19	11	((("6317288") or ("6466404") or ("6396660") or ("6339523") or ("6466401"))).PN.	USPAT; USOCR; JPO; DERWENT	OR	OFF	2005/08/30 14:07
S20	10	S11 and planariz\$3	USPAT; JPO; DERWENT	OR	ON	2005/08/30 14:09
S21	0	etch\$3 near (substrate or wafer) near (trench\$2 or cavit\$3) near coil	USPAT; JPO; DERWENT	OR	ON	2005/08/30 14:12
S22	205	(substrate or wafer) with (trench\$2 or cavit\$3) with coil	USPAT; JPO; DERWENT	OR	ON	2005/08/30 14:14
S23	16	(substrate or wafer) with (trench\$2 or cavit\$3) with coil	EPO; JPO	OR	ON	2005/08/30 14:15
S24	0	((trench\$2 or cavit\$3) near (form\$3 or embedd\$3) near coil) with planariz\$4	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:29
S25	6931	360/121-126,317.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:29
S26	6931	S25 or S25	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:29
S27	5215	29/592.1,603.12-603.16,603.18, 829,831,851,885.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:30
S28	419	S25 and S27	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:30
S29	11727	S25 or S27	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:30
S30	8	photoresist with deposit\$3 with coil with planariz\$5	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:31

S31	7	S30 and @ad<"20030825"	USPAT; JPO; DERWENT	OR	ON	2005/08/30 15:31
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IEEE JNL IEEE Journal or Magazine

IEE JNL IEE Journal or Magazine

IEEE CNF IEEE Conference Proceeding

IEE CNF IEE Conference Proceeding

IEEE STD IEEE Standard

Select Article Information

- ☒ 1. **Design and performance of a recessed thin film inductive transducer**  
 Zak, B.S.; Curland, N.; Giusti, J.H.; Ash, K.P.; Cameron, G.P.;  
 Magnetics, IEEE Transactions on  
 Volume 32, Issue 1, Jan. 1996 Page(s):74 - 79  
 Digital Object Identifier 10.1109/20.477553  
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- ☐ 2. **Thermomechanical head performance**  
 Pust, L.; Rea, C.J.T.; Gangopadhyay, S.;  
 Magnetics, IEEE Transactions on  
 Volume 38, Issue 1, Part 1, Jan. 2002 Page(s):101 - 106  
 Digital Object Identifier 10.1109/TMAG.2002.988919  
[AbstractPlus](#) | [References](#) | Full Text: [PDF\(282 KB\)](#) IEEE JNL
- ☐ 3. **Fabrication of submicron trackwidth thin film head and its inductance-sal characteristics**  
 Du, H.; Pan, G.;  
 Magnetics Conference, 2002. INTERMAG Europe 2002. Digest of Technical P  
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 28 April-2 May 2002 Page(s):AQ6  
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